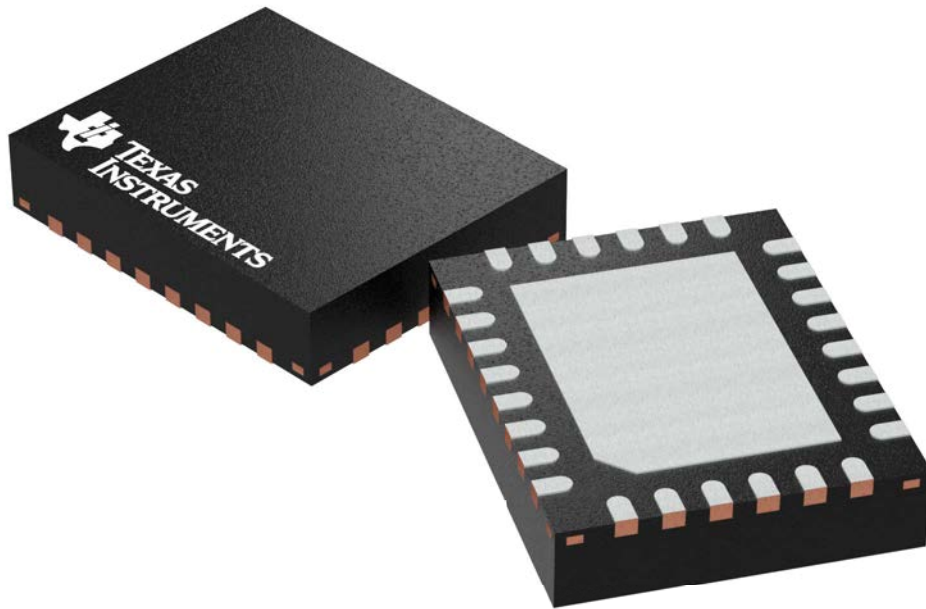


RHF 28

GENERIC PACKAGE VIEW

VQFN - 1.0 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4204845/J

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